# Lecture 3: More technology

Wednesday, January 9, 2019 6:40 PM

## Outline

- Energy and power of CMOS devices
- Trends in technology
- Start on ISA/instructions, if time

IF A RESEARCHER SAYS A COOL NEW TECHNOLOGY SHOULD BE AVAILABLE TO CONSUMERS IN...

WHAT THEY MEAN IS...

| THE FOURTH QUARTER<br>OF NEXT YEAR                              | THE PROJECT WILL BE<br>CANCELED IN SIX MONTHS.  |
|---|---|
| FIVE YEARS  | I'VE SOLVED THE INTERESTING<br>RESEARCH PROBLEMS. THE REST IS<br>JUST BUSINESS, WHICH IS EASY, RIGHT? |
| TEN YEARS   | WE HAVEN'T FINISHED INVENTING IT<br>YET, BUT WHEN WE DO, IT'LL BE AWESOME.                            |
| 25+ YEARS   | IT HAS NOT BEEN CONCLUSIVELY<br>PROVEN IMPOSSIBLE.  |
| WE'RE NOT REALLY<br>LOOKING AT MARKET<br>APPLICATIONS RIGHTNOW. | I LIKE BEING THE ONLY<br>ONE WITH A HOVERCAR.   |

## Energy and Power of CMOS devices

| 11     | energy and | J       |        |
|--------|------------|---------|--------|
| HOW OO | energy and | i nower | relate |

| Energy = | E | n | e | rg | ٧ | = |
|----------|---|---|---|----|---|---|
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Static energy:

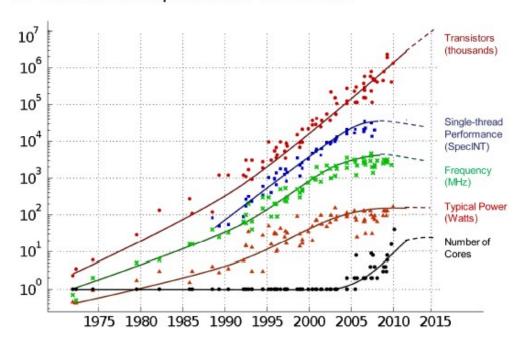
Dynamic energy:

Power:

If we are power/energy constrained: How do we reduce power/energy?

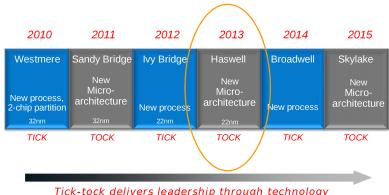
## **Trends**

# 35 Years of Microprocessor Trend Data



## Slides from Intel

### Intel Tick-Tock Model



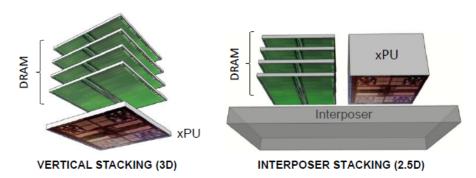
Tick-tock delivers leadership through technology innovation on a reliable and predictable timeline

(intel)

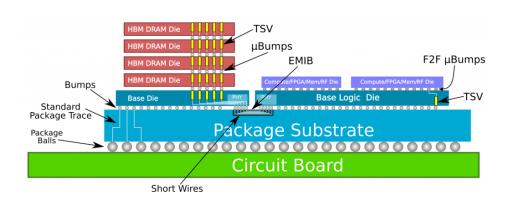
### DIE STACKING IS IDEAL FOR INTEGRATION

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· All they do is reduce metal interconnect by improving proximity of disparate technologies



40 | DIE STACKING IS HAPPENING! | DECEMBER 9, 2013



### John Hennessy and David Patterson 2017 ACM A.M. Turing Award Lecture

